

20 / 20 V, 725 / 500 mA N/P-channel Trench MOSFET 28 March 2014

Product data sheet

General description 1.

Complementary N/P-channel enhancement mode Field-Effect Transistor (FET) in a very small SOT363 Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

Features and benefits 2.

- Very fast switching •
- Trench MOSFET technology •
- 2 kV ESD protection •
- AEC-Q101 qualified

Applications 3.

- Relay driver
- High-speed line driver
- Low-side loadswitch
- Switching circuits
- Automotive applications •

Quick reference data 4.

Table 1. C	uick reference data						
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
TR1 (N-cha	nnel), Static characteristic	cs					
R _{DSon}	drain-source on-state resistance	V_{GS} = 4.5 V; I _D = 500 mA; T _j = 25 °C		-	290	380	mΩ
TR2 (P-chai	nnel), Static characteristic	SS					
R _{DSon}	drain-source on-state resistance	V _{GS} = -4.5 V; I _D = -400 mA; T _j = 25 °C		-	670	850	mΩ
TR1 (N-cha	nnel)						
V _{DS}	drain-source voltage	T _j = 25 °C		-	-	20	V
V _{GS}	gate-source voltage	-		-8	-	8	V
I _D	drain current	V _{GS} = 4.5 V; T _{amb} = 25 °C	[1]	-	-	725	mA
TR2 (P-chai	nnel)		1				
V _{DS}	drain-source voltage	T _j = 25 °C		-	-	-20	V

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Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
V _{GS}	gate-source voltage			-8	-	8	V
I _D	drain current	V _{GS} = -4.5 V; T _{amb} = 25 °C	[1]	-	-	-500	mA

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm².

5. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S1	source TR1	6 5 4	D1 D2
2	G1	gate TR1		
3	D2	drain TR2		
4	S2	source TR2		
5	G2	gate TR2	TSSOP6 (SOT363)	
6	D1	drain TR1		S1 S2 017aaa262

6. Ordering information

Table 3. Ordering information							
Type number	Package						
	Name	Description	Version				
PMGD290UCEA	TSSOP6	plastic surface-mounted package; 6 leads	SOT363				

7. Marking

Table 4. Marking codes								
Type number	Marking code							
	[1]							
PMGD290UCEA	YD%							

[1] % = placeholder for manufacturing site code

8. Limiting values

Table 5.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter		Conditions		Min	Max	Unit
TR1 (N-channel)							
V _{DS}	drain-source voltage		T _j = 25 °C		-	20	V
V _{GS}	gate-source voltage				-8	8	V
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Symbol	Parameter	Conditions		Min	Max	Unit
I _D	drain current	V _{GS} = 4.5 V; T _{amb} = 25 °C	[1]	-	725	mA
		V _{GS} = 4.5 V; T _{amb} = 100 °C	[1]	-	450	mA
I _{DM}	peak drain current	T_{amb} = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	3	Α
P _{tot}	total power dissipation	T _{amb} = 25 °C	[2]	-	280	mW
			[1]	-	320	mW
		T _{sp} = 25 °C		-	990	mW
TR1 (N-cha	nnel), Source-drain diode					
I _S	source current	T _{amb} = 25 °C	[1]	-	370	mA
TR1 N-char	nnel), ESD maximum rating					
V _{ESD}	electrostatic discharge voltage	НВМ	[3]	-	2000	V
TR2 (P-cha	nnel)	,	1		1	
V _{DS}	drain-source voltage	T _j = 25 °C		-	-20	V
V _{GS}	gate-source voltage			-8	8	V
I _D	drain current	V _{GS} = -4.5 V; T _{amb} = 25 °C	[1]	-	-500	mA
		V _{GS} = -4.5 V; T _{amb} = 100 °C	[1]	-	-320	mA
I _{DM}	peak drain current	T_{amb} = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	-2	Α
P _{tot}	total power dissipation	T _{amb} = 25 °C	[2]	-	280	mW
			[1]	-	320	mW
		T _{sp} = 25 °C		-	990	mW
TR2 (P-cha	nnel), Source-drain diode	1			1	
I _S	source current	T _{amb} = 25 °C	[1]	-	-370	mA
TR2 (P-cha	nnel), ESD maximum rating	1				
V _{ESD}	electrostatic discharge voltage	НВМ	[3]	-	2000	V
Per device		1				
P _{tot}	total power dissipation	T _{amb} = 25 °C	[2]	-	445	mW
Tj	junction temperature			-55	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

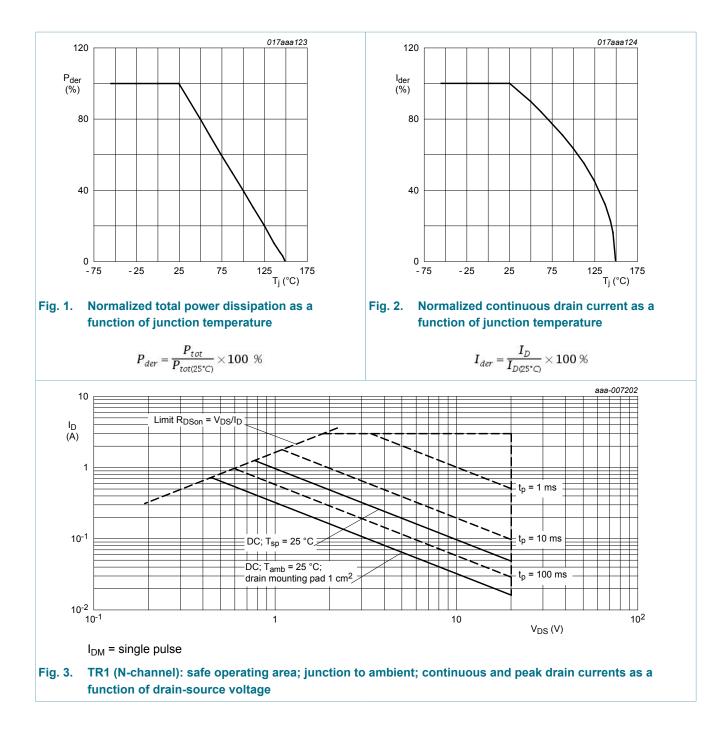
[1]

Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm². Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper; tin-plated and standard [2] footprint.

[3] Measured between all pins.

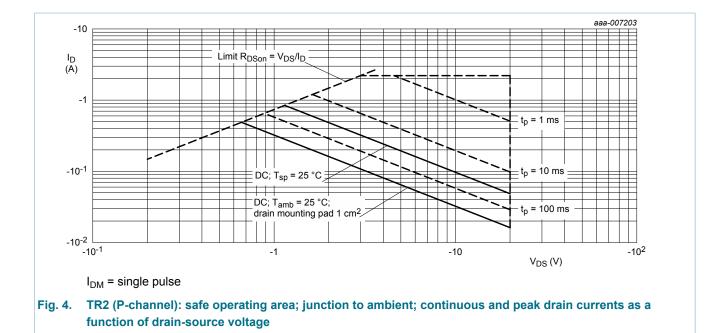
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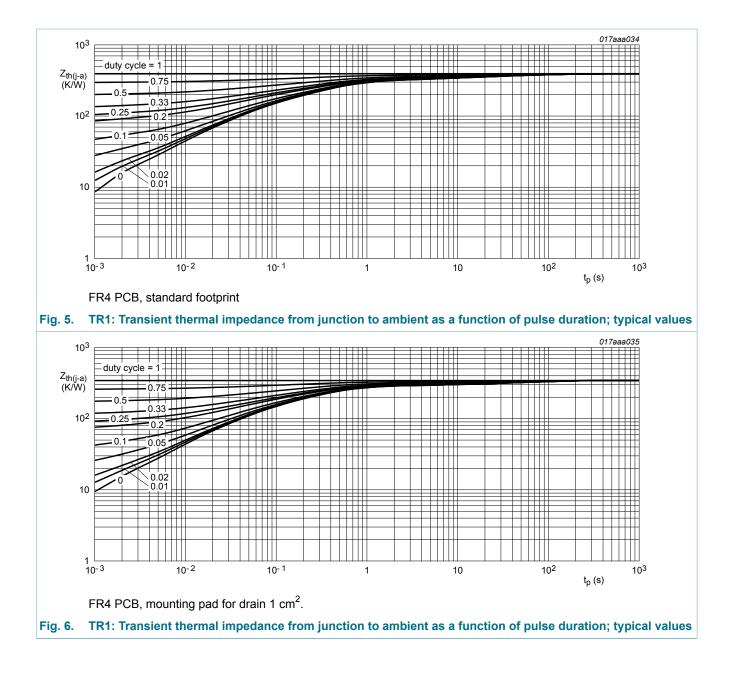
9. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
TR1 (N-cha	nnel)	1	1				
R _{th(j-a)}	thermal resistance	in free air	[1]	-	390	445	K/W
	from junction to ambient		[2]	-	340	390	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point			-	-	130	K/W
TR2 (P-cha	nnel)	1					
R _{th(j-a)}	thermal resistance	in free air	[1]	-	390	445	K/W
	from junction to ambient		[2]	-	340	390	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point			-	-	130	K/W
Per device		·					
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1]	-	-	300	K/W

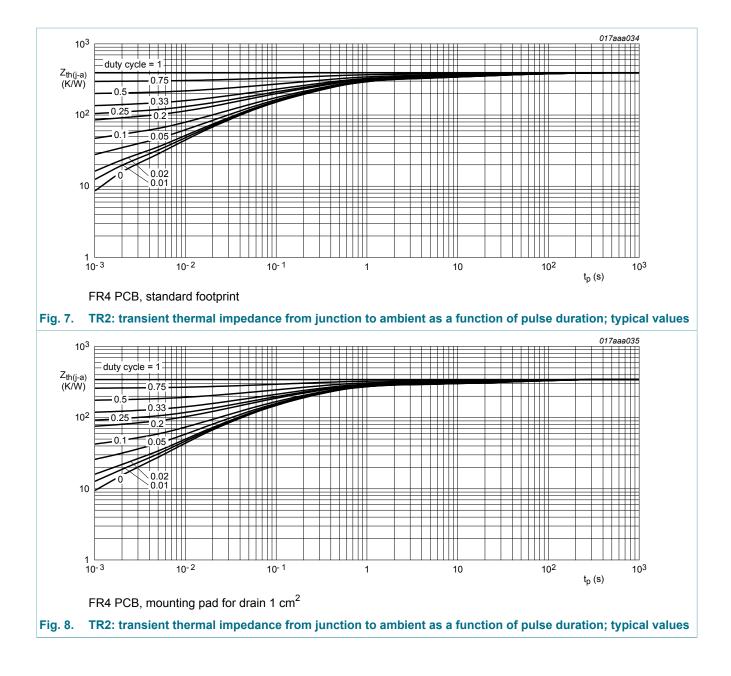
[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper; tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 1 cm².

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10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TR1 (N-chai	nnel), Static characteristic	S				
V _{(BR)DSS}	drain-source breakdown voltage	I_D = 250 µA; V_{GS} = 0 V; T_j = 25 °C	20	-	-	V
V _{GSth}	gate-source threshold voltage	I_D = 250 µA; V_{DS} = V_{GS} ; T_j = 25 °C	0.5	0.75	0.95	V
I _{DSS}	drain leakage current	V_{DS} = 20 V; V_{GS} = 0 V; T_j = 25 °C	-	-	1	μA
		V_{DS} = 20 V; V_{GS} = 0 V; T_j = 150 °C	-	-	10	μA
I _{GSS}	gate leakage current	V _{GS} = 8 V; V _{DS} = 0 V; -40 °C < T _j < 150 °C	-	-	10	μA
		V _{GS} = -8 V; V _{DS} = 0 V; -40 °C < T _j < 150 °C	-	-	-10	μA
R _{DSon}	drain-source on-state resistance	V_{GS} = 4.5 V; I _D = 500 mA; T _j = 25 °C	-	290	380	mΩ
		V _{GS} = 4.5 V; I _D = 500 mA; T _j = 150 °C	-	460	610	mΩ
		V_{GS} = 2.5 V; I _D = 200 mA; T _j = 25 °C	-	420	620	mΩ
		V _{GS} = 1.8 V; I _D = 10 mA; T _j = 25 °C	-	0.6	1.1	Ω
9 _{fs}	transfer conductance	V_{DS} = 10 V; I _D = 200 mA; T _j = 25 °C	-	1.6	-	S
TR1 (N-chai	nnel), Dynamic characteris	stics	l l		1	
Q _{G(tot)}	total gate charge	V_{DS} = 10 V; I _D = 500 mA; V _{GS} = 4.5 V;	-	0.45	0.68	nC
Q _{GS}	gate-source charge	T _j = 25 °C	-	0.15	-	nC
Q _{GD}	gate-drain charge		-	0.15	-	nC
C _{iss}	input capacitance	V _{DS} = 10 V; f = 1 MHz; V _{GS} = 0 V;	-	55	83	pF
C _{oss}	output capacitance	T _j = 25 °C	-	15	-	pF
C _{rss}	reverse transfer capacitance		-	7	-	pF
t _{d(on)}	turn-on delay time	V_{DS} = 10 V; R_L = 250 Ω ; V_{GS} = 4.5 V;	-	6	12	ns
t _r	rise time	R _{G(ext)} = 6 Ω; T _j = 25 °C	-	4	-	ns
t _{d(off)}	turn-off delay time		-	86	172	ns
t _f	fall time		-	31	-	ns
TR1 (N-chai	nnel), Source-drain diode	characteristics	·			
V _{SD}	source-drain voltage	I_{S} = 300 mA; V_{GS} = 0 V; T_{j} = 25 °C	0.48	0.77	1.2	V
TR2 (P-char	nnel), Static characteristic	S				
V _{(BR)DSS}	drain-source breakdown voltage	I_D = -250 µA; V_{GS} = 0 V; T_j = 25 °C	-20	-	-	V

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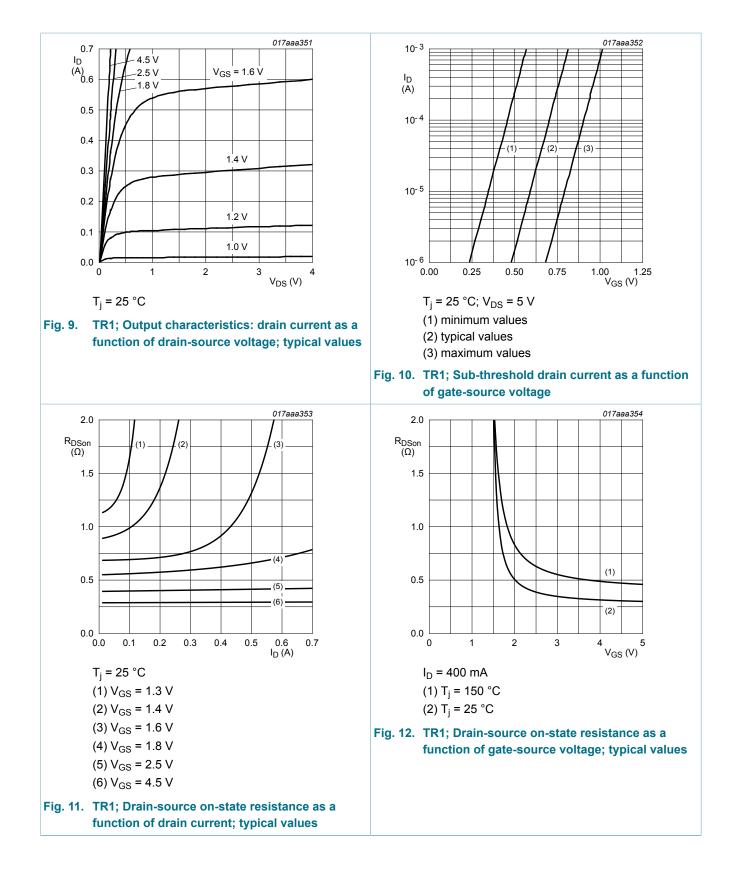
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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{GSth}	gate-source threshold voltage	I_D = -250 µA; V_{DS} = V_{GS} ; T_j = 25 °C	-0.5	-0.8	-1.3	V
I _{DSS}	drain leakage current	V_{DS} = -20 V; V_{GS} = 0 V; T_j = 25 °C	-	-	-1	μA
		V _{DS} = -20 V; V _{GS} = 0 V; T _j = 150 °C	-	-	-10	μA
I _{GSS}	gate leakage current	V _{GS} = 8 V; V _{DS} = 0 V; -40 °C < T _j < 150 °C	-	-	10	μA
		V _{GS} = -8 V; V _{DS} = 0 V; -40 °C < T _j < 150 °C	-	-	-10	μA
R _{DSon}	drain-source on-state	V_{GS} = -4.5 V; I _D = -400 mA; T _j = 25 °C	-	670	850	mΩ
	resistance	V_{GS} = -4.5 V; I _D = -400 mA; T _j = 150 °C	-	1.1	1.4	Ω
		V_{GS} = -2.5 V; I _D = -200 mA; T _j = 25 °C	-	1.2	1.5	Ω
		V _{GS} = -1.8 V; I _D = -10 mA; T _j = 25 °C	-	1.8	2.8	Ω
9 _{fs}	transfer conductance	V _{DS} = -10 V; I _D = -200 mA; T _j = 25 °C	-	610	-	mS
TR2 (P-cha	nnel), Dynamic characteri	stics				
Q _{G(tot)}	total gate charge	V _{DS} = -10 V; I _D = -400 mA;	-	0.76	1.14	nC
Q _{GS}	gate-source charge	V _{GS} = -4.5 V; T _j = 25 °C	-	0.28	-	nC
Q _{GD}	gate-drain charge		-	0.18	-	nC
C _{iss}	input capacitance	V_{DS} = -10 V; f = 1 MHz; V_{GS} = 0 V;	-	58	87	pF
C _{oss}	output capacitance	T _j = 25 °C	-	21	-	pF
C _{rss}	reverse transfer capacitance		-	12	-	pF
t _{d(on)}	turn-on delay time	V_{DS} = -10 V; R _L = 250 Ω; V _{GS} = -4.5 V;	-	18	36	ns
t _r	rise time	$R_{G(ext)} = 6 \Omega; T_j = 25 °C$	-	30	-	ns
t _{d(off)}	turn-off delay time	1	-	80	160	ns
t _f	fall time	1	-	72	-	ns
TR2 (P-cha	nnel), Source-drain diode	characteristics	I	1		
V _{SD}	source-drain voltage	I _S = -300 mA; V _{GS} = 0 V; T _i = 25 °C	-0.48	-0.84	-1.2	V

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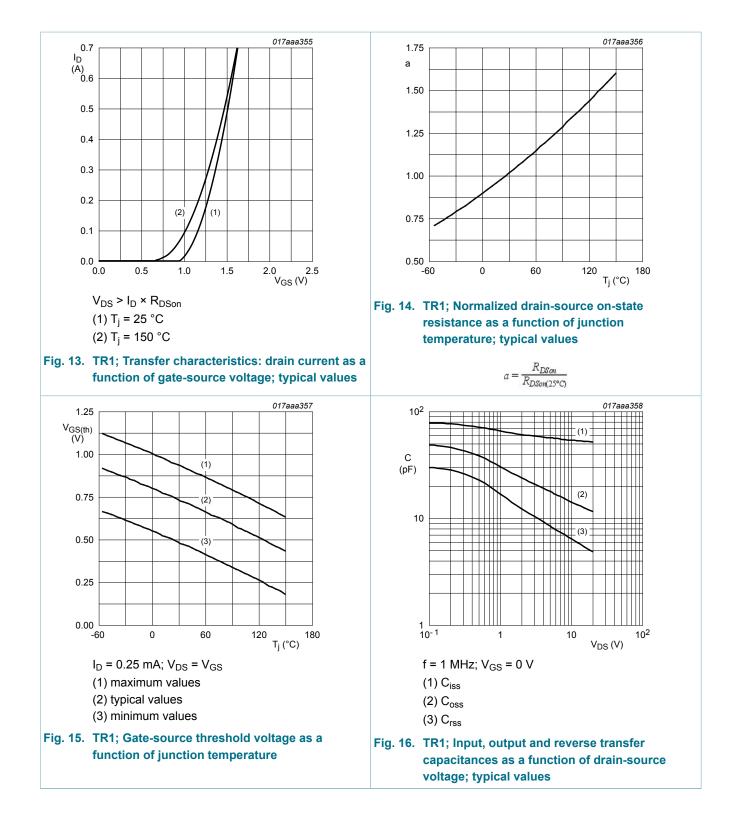
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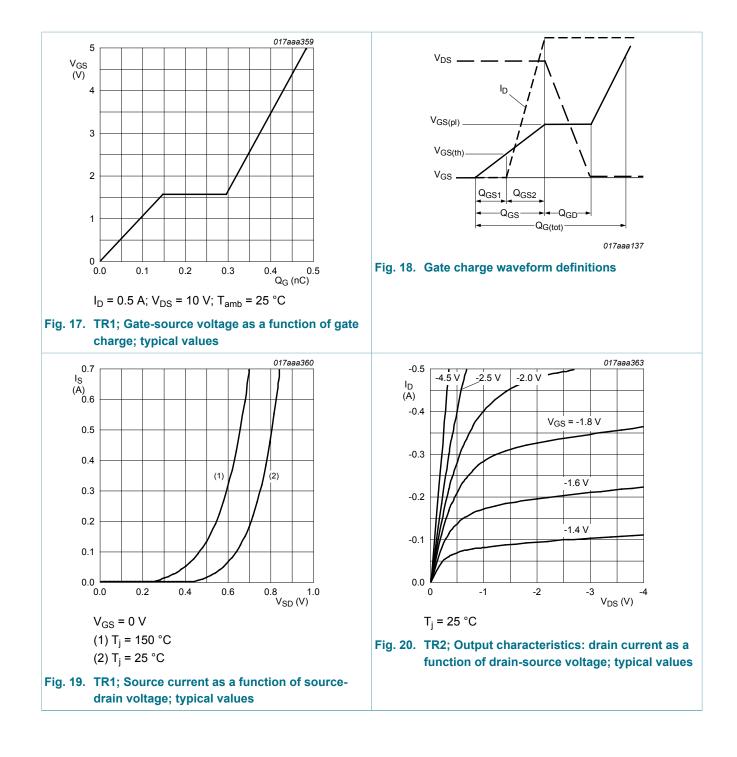
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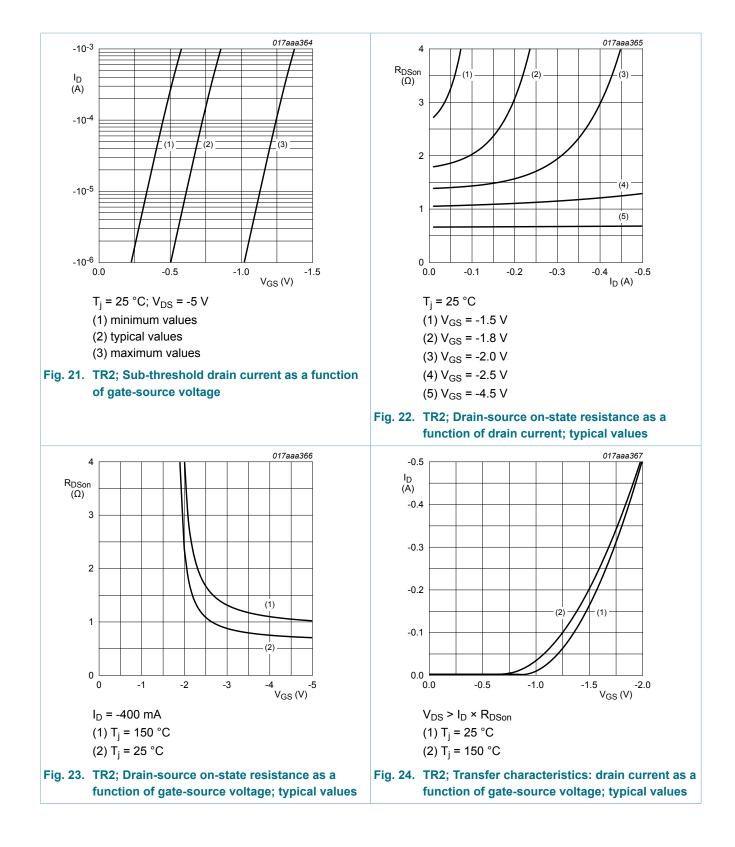


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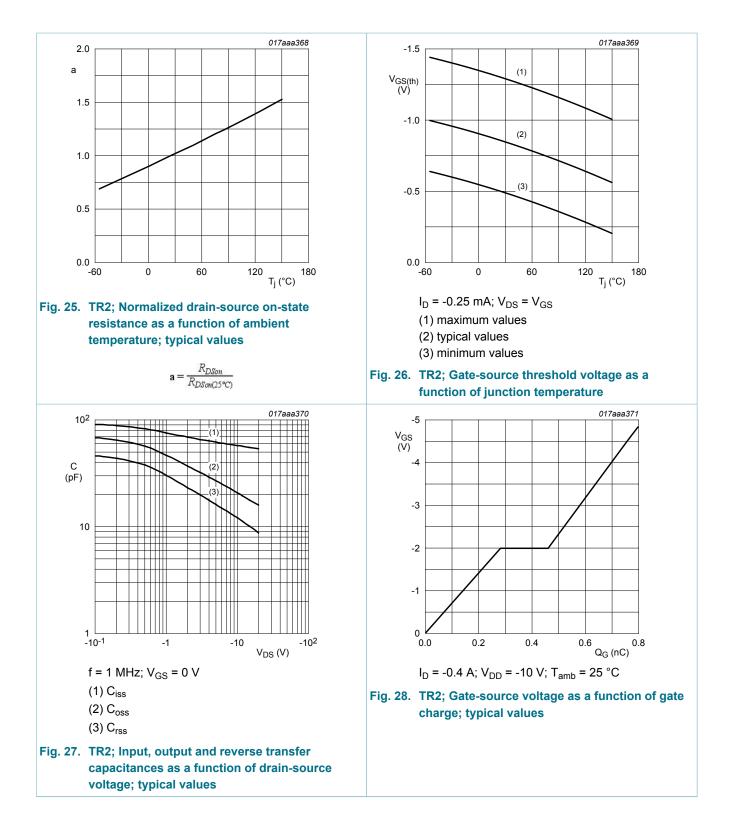


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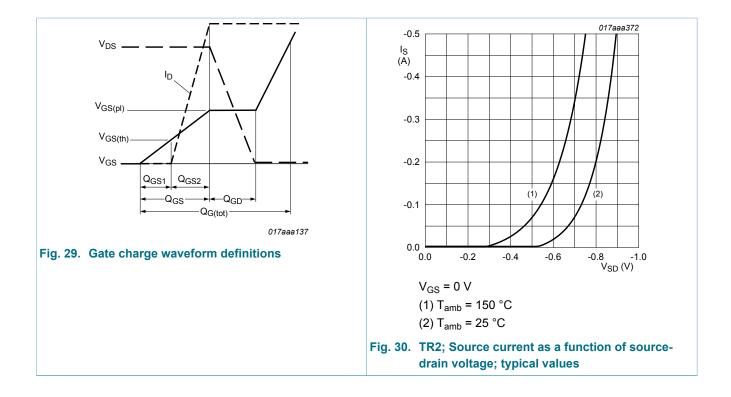
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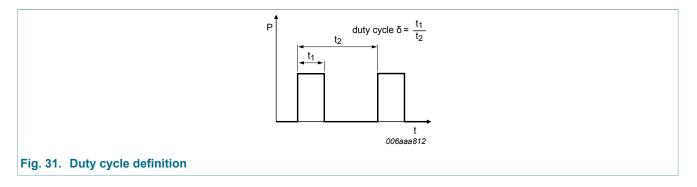
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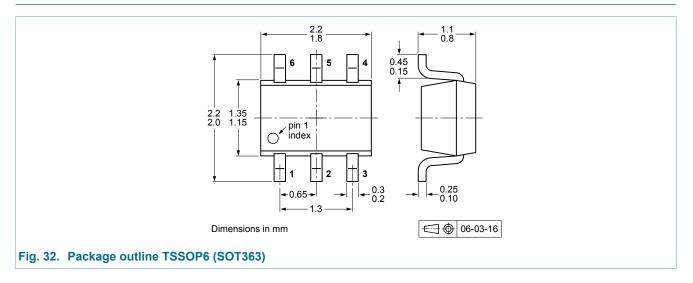
11. Test information



11.1 Quality information

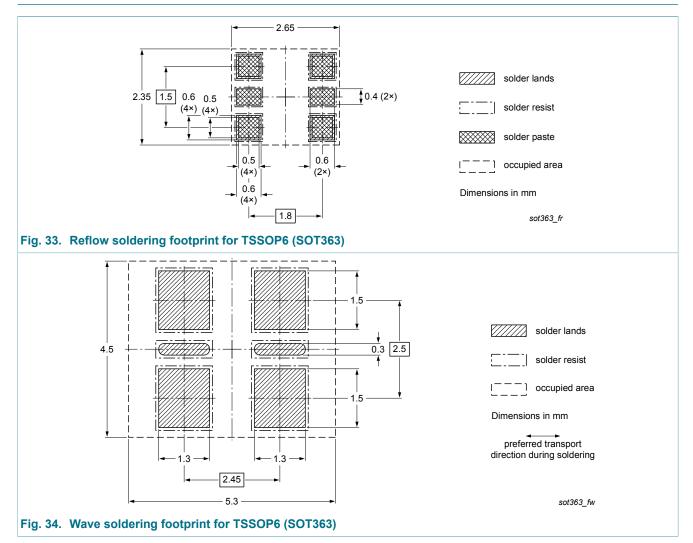
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline



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13. Soldering



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14. Revision history

Table 8. Revision history								
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes				
PMGD290UCEA v.3	20140328	Product data sheet	-	PMGD290UCEA v.2				
Modifications:	Table 7: I _{GSS} param	eter unit corrected						
PMGD290UCEA v.2	20130418	Product data sheet	-	PMGD290UCEA v.1				
PMGD290UCEA v.1	20130415	Product data sheet	-	-				

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15. Legal information

15.1 Data sheet status

Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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